

Low power consumption, Low dropout voltage, With CE function

General Description

GX6213 series are highly precise, low power consumption, high voltage, positive voltage regulators manufactured using CMOS and laser trimming technologies. The series provides large currents with a significantly small dropout voltage.

The current limiter's foldback circuit also operates as a short protect for the output current limiter and the output pin. The CE function allows the output of regulator to be turned off, resulting in greatly reduced power consumption.

Typical Application

- Battery powered equipment
- Communication tools
- Mobile phones
- Portable games
- Portable AV systems
- Cameras, Video systems
- Reference voltage sources

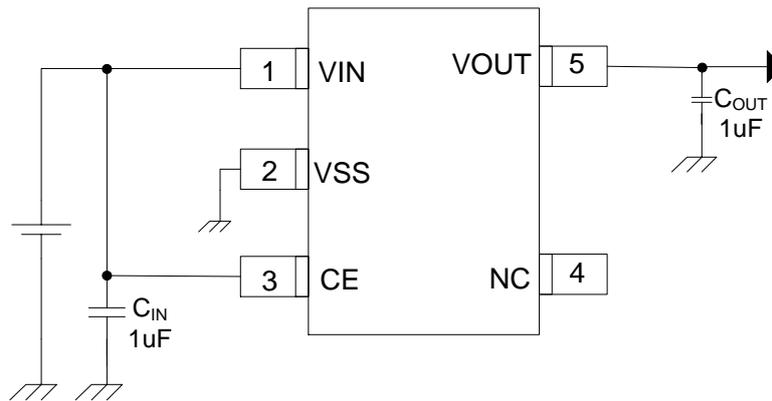
Features

- Highly Accurate: $V_{out}=3.3V: \pm 1\%$
Others: $\pm 2\%$
- Output voltage range: 1.2V~5.0V
- Low power consumption: 7.5uA(TYP.)
- Large output current:
300mA ($V_{IN}=3.8V, V_{OUT}=2.8V$)
- Input voltage: up to 6 V
- Dropout voltage:
0.11V at 100mA and 0.23V at 200mA
- CE Pin Function : Active High
- Short-circuit Current: 45mA(TYP.)
- Excellent Input Stability
- Be available to regulator and reference voltage

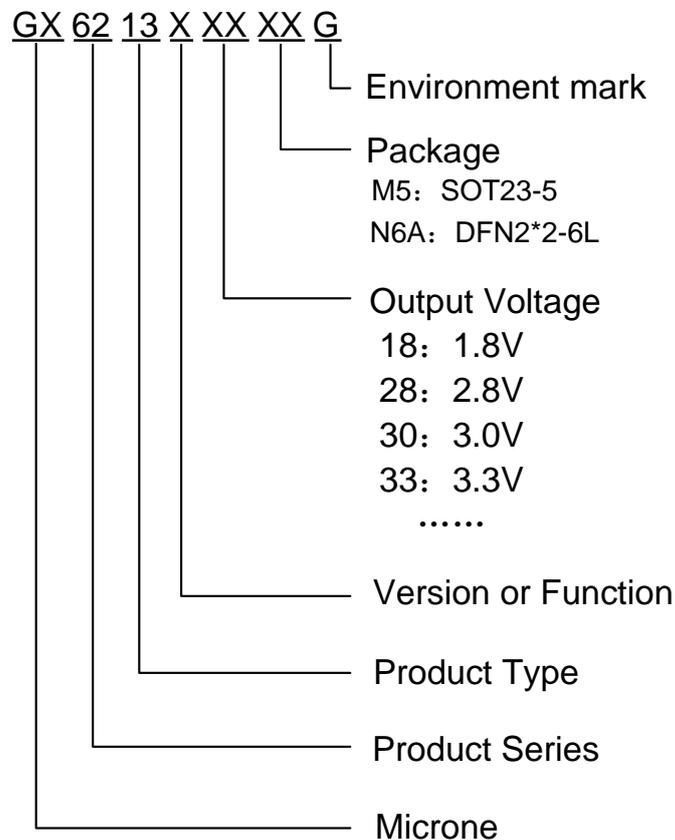
Package

- 5-pin SOT23-5
- 6-pin DFN2×2-6L

Typical Application Circuit



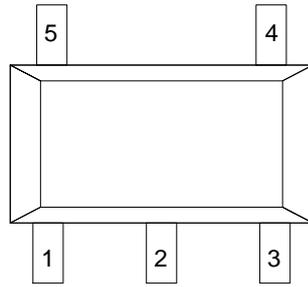
Selection Guide



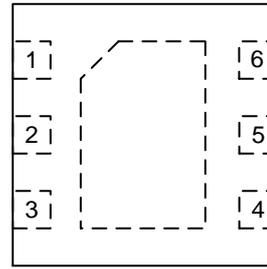
product series	Output voltage	Package
GX6213C18M5G	1.8V	SOT23-5
GX6213C28M5G	2.8V	SOT23-5
GX6213C30M5G	3.0V	SOT23-5
GX6213C33M5G	3.3V	SOT23-5
GX6213C33N6AG	3.3V	DFN2*2-6L

NOTE: If you need other voltage and package, please contact our sales staff.

Pin Configuration



SOT23-5



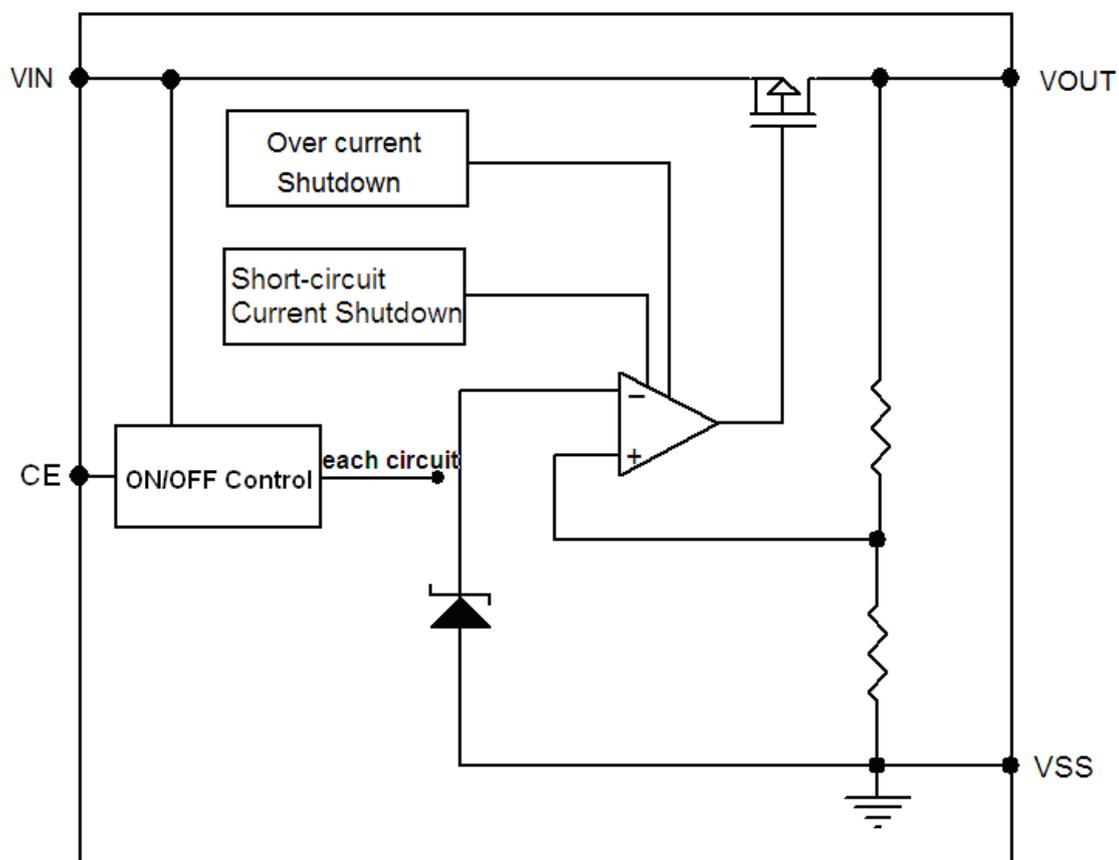
DFN2*2-6L

Pin Assignment

Pin Number	Pin Name	Functions
SOT23-5		
1	V_{IN}	Power Input
2	V_{SS}	Ground
3	CE	ON / OFF Control
4	NC	No Connect
5	V_{OUT}	Output

Pin Number	Pin Name	Functions
DFN2×2-6L		
1	CE	ON / OFF Control
2	V_{SS}	Ground
3	V_{IN}	Power Input
4	V_{OUT}	Output
5	NC	No Connect
6	NC	No Connect

Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Ratings	Units
Input Voltage	V_{IN}	6.5	V
Output Current	I_{OUT}	420	mA
Output Voltage	V_{OUT}	$V_{SS}-0.3 \sim V_{IN} + 0.3$	V
CE Pin Voltage	V_{CE}	$V_{SS}-0.3 \sim V_{IN} + 0.3$	V
Power Dissipation	SOT23-5 P_D	250	mW
Operating Temperature Range	T_{OPR}	$-40 \sim +85$	$^{\circ}C$
Storage Temperature Range	T_{STG}	$-55 \sim +150$	$^{\circ}C$
Lead Temperature		$260^{\circ}C, 4sec$	

Electrical Characteristics

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($V_{IN} = V_{OUT} + 1V$, $V_{CE} = V_{IN}$, $C_{IN} = C_{OUT} = 1\mu F$, $T_a = 25^{\circ}C$, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Output Voltage	$V_{OUT(E)}$ (Note 2)	$I_{OUT} = 30mA$, $V_{IN} = V_{OUT} + 1V$	X 0.98	$V_{OUT(T)}$ (Note 1)	X 1.02	V
Input Voltage	V_{IN}		2.8		6	V
Maximum Output Current	I_{OUTMAX}	$V_{IN} = V_{OUT} + 1V$		300		mA
Load Regulation	ΔV_{OUT}	$V_{IN} = V_{OUT} + 1V$,		4		mV

		$1\text{mA} \leq I_{\text{OUT}} \leq 100\text{mA}$				
Dropout Voltage(Note 1)	V_{DIF1}	$I_{\text{OUT}} = 100\text{mA}$		110		mV
	V_{DIF2}	$I_{\text{OUT}} = 200\text{mA}$		230		mV
Supply Current	I_{SS}	$V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$		7.5		μA
Stand-by Current	I_{CEL}	$V_{\text{CE}} = 0\text{V}$		0.02		μA
Line Regulation	ΔV_{OUT}	$I_{\text{OUT}} = 30\text{mA}$ $V_{\text{OUT}} + 1\text{V} \leq V_{\text{IN}} \leq 6\text{V}$		5		mV
CE "High" Voltage	V_{CEH}	Start up	1.0			V
CE "Low" Voltage	V_{CEL}	Shut down			0.5	V
Short-circuit Current	I_{SHORT}	$V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$, $V_{\text{CE}} = V_{\text{IN}}$, $V_{\text{OUT}} = 0\text{V}$		45		mA
Over Current Protection	I_{limit}	$V_{\text{IN}} = 3.8\text{V}$		430		mA

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($V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$, $V_{\text{CE}} = V_{\text{IN}}$, $C_{\text{IN}} = C_{\text{OUT}} = 1\mu\text{F}$, $T_a = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Output Voltage	$V_{\text{OUT}}(\text{E})$ (Note 2)	$I_{\text{OUT}} = 30\text{mA}$, $V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$	X 0.99	$V_{\text{OUT}}(\text{T})$ (Note 1)	X 1.01	V
Input Voltage	V_{IN}		3.3		6	V
Maximum Output Current	I_{OUTMAX}	$V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$		350		mA
Load Regulation	ΔV_{OUT}	$V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$, $1\text{mA} \leq I_{\text{OUT}} \leq 100\text{mA}$		4		mV
Dropout Voltage (Note 1)	V_{DIF1}	$I_{\text{OUT}} = 100\text{mA}$		100		mV
	V_{DIF2}	$I_{\text{OUT}} = 200\text{mA}$		200		mV
Supply Current	I_{SS}	$V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$		7.5		μA
Stand-by Current	I_{CEL}	$V_{\text{CE}} = 0\text{V}$		0.02		μA
Line Regulation	ΔV_{OUT}	$I_{\text{OUT}} = 30\text{mA}$ $V_{\text{OUT}} + 1\text{V} \leq V_{\text{IN}} \leq 6\text{V}$		4		mV
CE "High" Voltage	V_{CEH}	Start up	1.0			V
CE "Low" Voltage	V_{CEL}	Shut down			0.5	V
Short-circuit Current	I_{SHORT}	$V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$, $V_{\text{CE}} = V_{\text{IN}}$, $V_{\text{OUT}} = 0\text{V}$		45		mA
Over Current Protection	I_{limit}	$V_{\text{IN}} = 4.3\text{V}$		440		mA

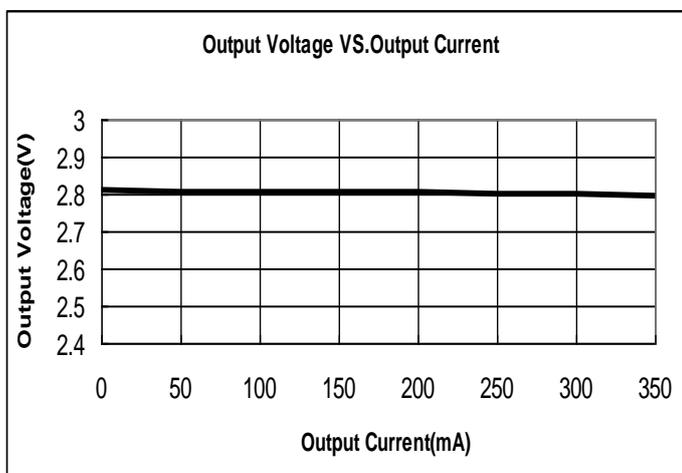
Note :

- $V_{\text{OUT}}(\text{T})$: Specified Output Voltage
- $V_{\text{OUT}}(\text{E})$: Effective Output Voltage (i.e. The output voltage when " $V_{\text{OUT}}(\text{T}) + 1.0\text{V}$ " is provided at the V_{in} pin while maintaining a certain I_{out} value.)
- V_{DIF} : $V_{\text{IN1}} - V_{\text{OUT}}(\text{E})'$
 V_{IN1} : The input voltage when $V_{\text{OUT}}(\text{E})'$ appears as input voltage is gradually decreased.
 $V_{\text{OUT}}(\text{E})'$: A voltage equal to 98% of the output voltage whenever an amply stabilized $I_{\text{out}} \{V_{\text{OUT}}(\text{T}) + 1.0\text{V}\}$ is input.

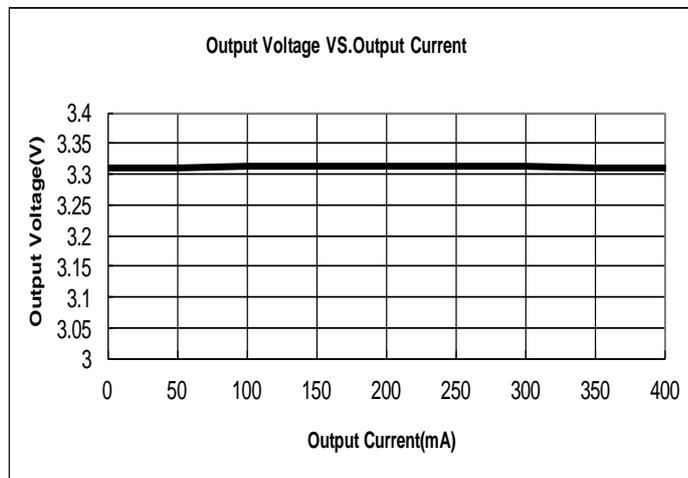
Type Characteristics

(1) Output Voltage VS. Output Current ($V_{IN}=V_{OUT}+1$, $T_a = 25\text{ }^\circ\text{C}$)

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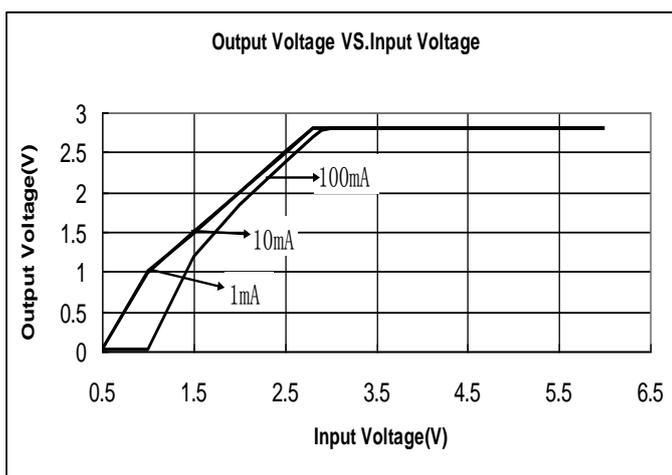


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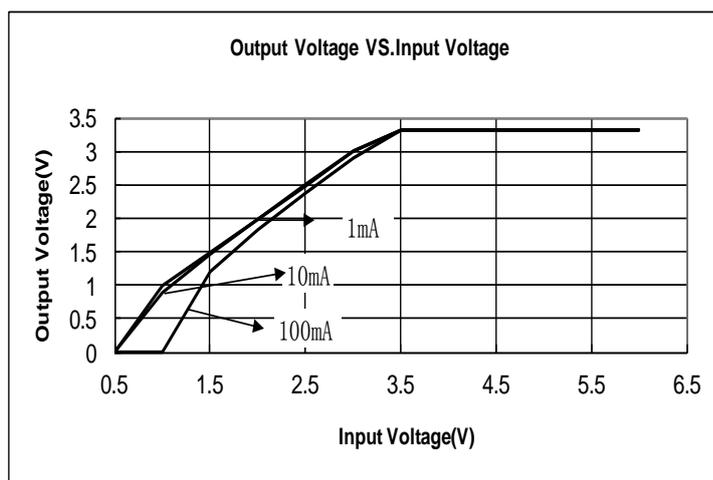


(2) Output Voltage VS. Input Voltage ($T_a = 25\text{ }^\circ\text{C}$)

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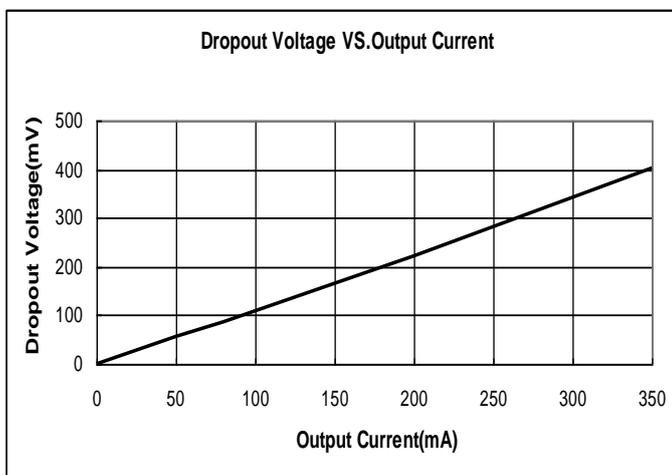


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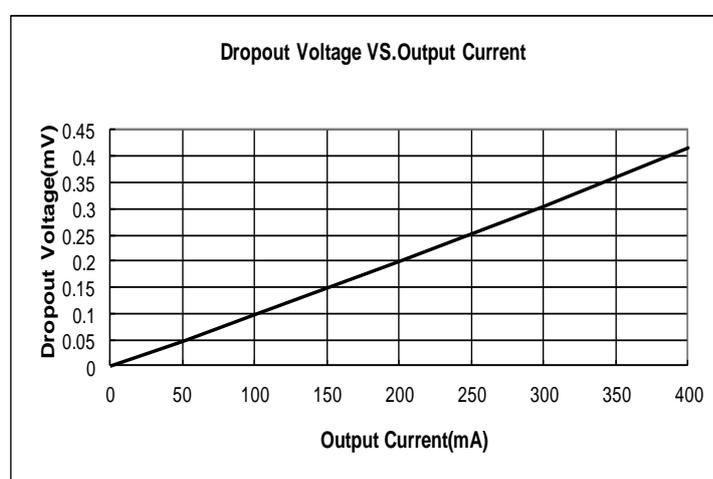


(3) Dropout Voltage VS. Output Current ($V_{IN}=V_{OUT}+1V$, $T_a = 25\text{ }^\circ\text{C}$)

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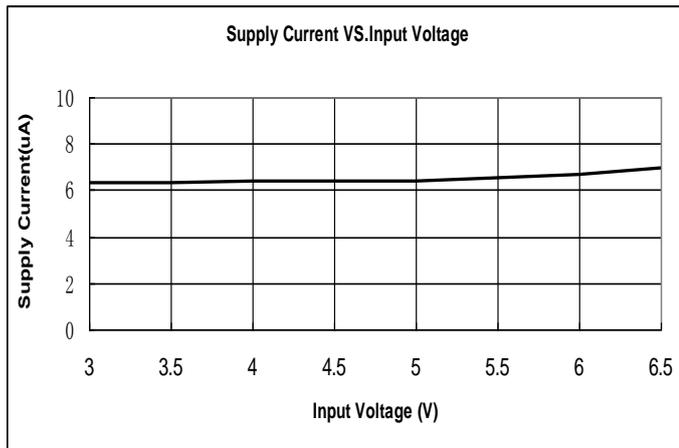


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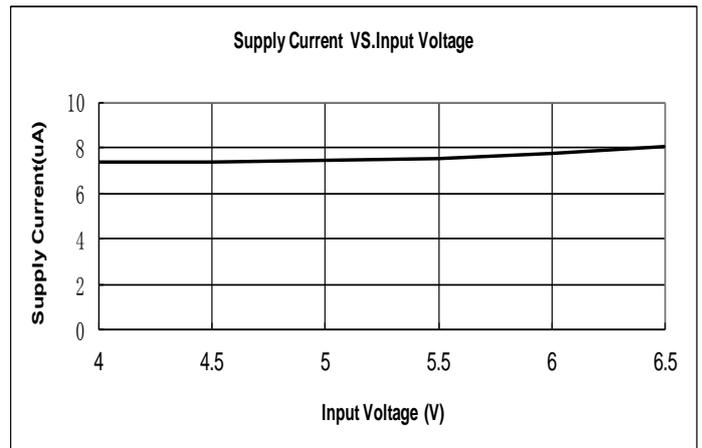


(4) Supply Current VS. Input Voltage ($T_a = 25\text{ }^\circ\text{C}$)

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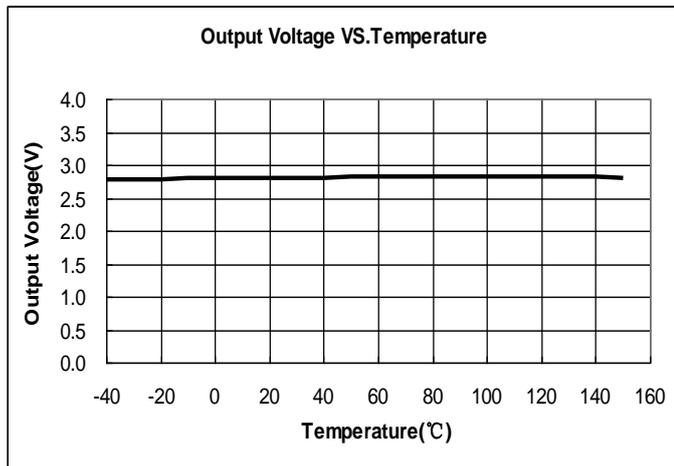


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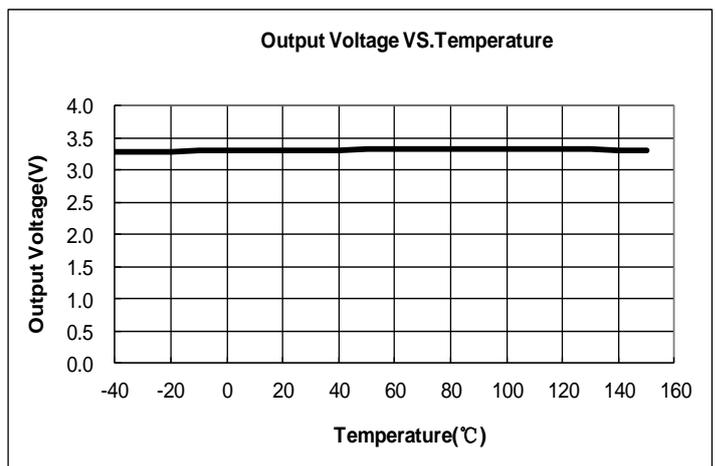


(5) Output Voltage VS. Temperature ($V_{IN}=V_{OUT}+1V$, $I_{OUT}=10mA$)

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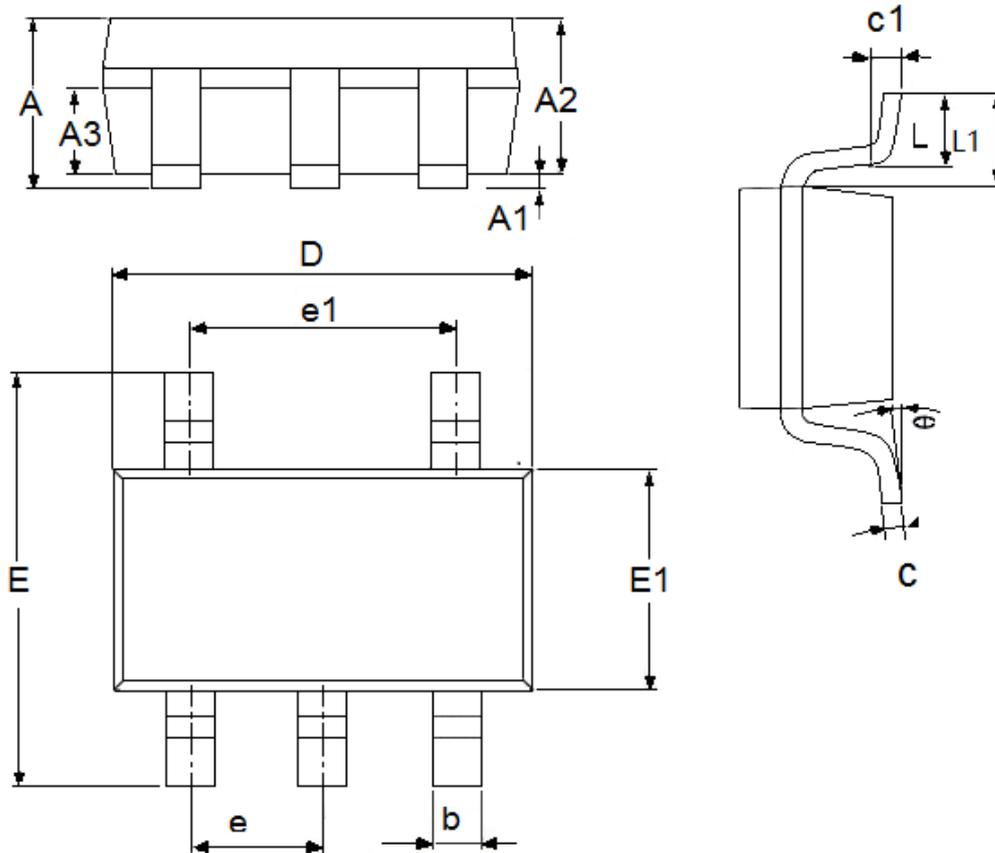


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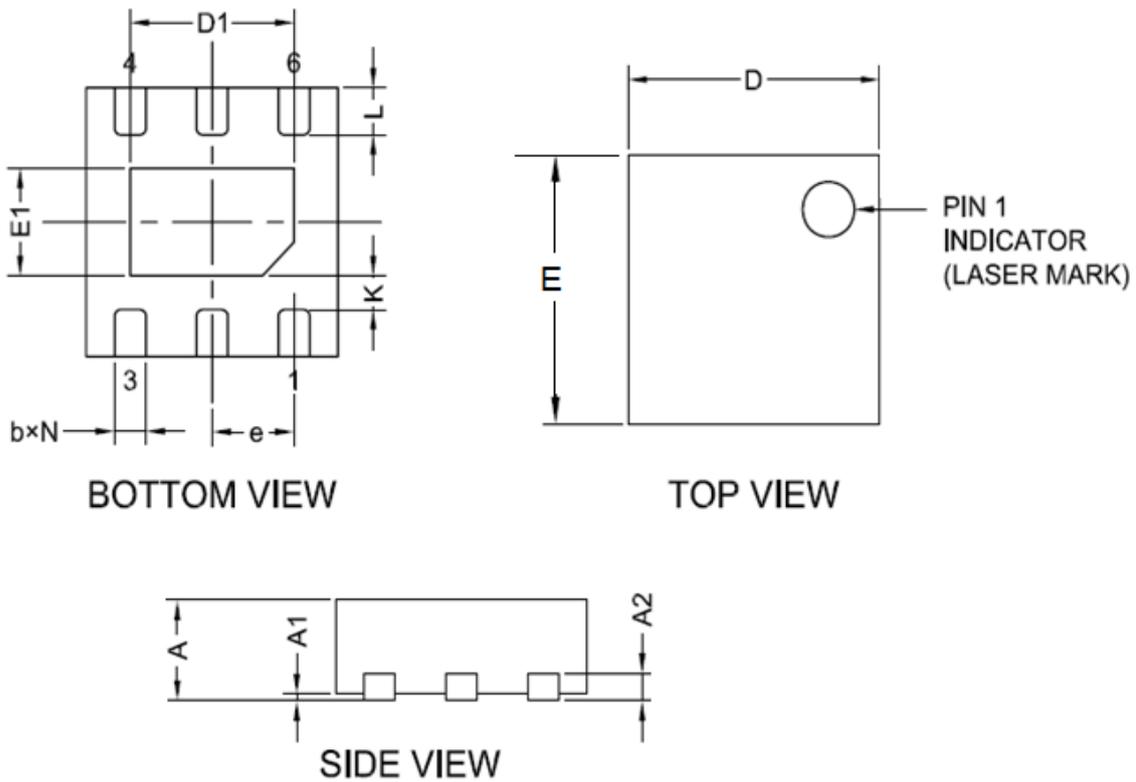
Packaging Information

- SOT23-5L



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	1.05	1.45	0.0413	0.0571
A1	0	0.15	0.0000	0.0059
A2	0.9	1.3	0.0354	0.0512
A3	0.6	0.7	0.0236	0.0276
b	0.25	0.5	0.0098	0.0197
c	0.1	0.23	0.0039	0.0091
D	2.82	3.05	0.1110	0.1201
e1	1.9(TYP)		0.0748(TYP)	
E	2.6	3.05	0.1024	0.1201
E1	1.5	1.75	0.0512	0.0689
e	0.95(TYP)		0.0374(TYP)	
L	0.25	0.6	0.0098	0.0236
L1	0.59(TYP)		0.0232(TYP)	
θ	0	8°	0.0000	8°
c1	0.2(TYP)		0.0079(TYP)	

● DFN2x2-6L



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	0.7	0.8	0.0276	0.0315
A1	0	0.05	0	0.002
A2	0.203(TYP)		0.008(TYP)	
b	0.2	0.35	0.0078	0.0138
D	1.9	2.1	0.0748	0.0827
E	1.9	2.1	0.0748	0.0827
E1	0.5	0.9	0.0197	0.0354
e	0.65(TYP)		0.0256(TYP)	
L	0.25	0.426	0.0098	0.0168
K	0.2	—	0.0079	—
D1	1	1.45	0.0393	0.0571

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